

# 600V Super-junction Power MOSFET

## Description

#### 600V Super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The Multi-EPI SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

	aomos company.				
Features		Applications			
• Very low FOM R <sub>DS(on)</sub>	imesQ <sub>g</sub>	Switch Mode Pow	Switch Mode Power Supply (SMPS)		
<ul> <li>100% avalanche tested</li> </ul>		Uninterruptible P	ower Supply (UPS)		
<ul> <li>Easy to use/drive</li> </ul>		<ul> <li>Power Factor Co</li> </ul>	rrection (PFC)		
<ul> <li>RoHS compliant</li> </ul>		Charger			
TO-220F	TO-3PN TO-247	Drain			
GDS		Gate	RoHS		
Device Marking a	nd Package Information				
Device	Package		Marking		
TPA60R080M	TO-220F		60R080M		
TPV60R080M	TO-3PN		60R080M		
TPW60R080M	TO-247		60R080M		
Key Performance	e Parameters				
Parameter	Value		Unit		
V <sub>DS</sub> @ T <sub>j,max</sub>	650		V		
R <sub>DS(on),max</sub>	0.08		Ω		
Q <sub>g,typ</sub>	75		nC		
I <sub>D</sub>	47		A		
I <sub>D,pulse</sub>	141		A		
E <sub>oss</sub> @ 400V	11.05		μJ		
Body Diode di <sub>F</sub> /dt	500		A/µs		



Absolute Maximum Ratings T <sub>c</sub> = 25°C, unless otherwise noted						
Parameter			Symbol	Value	Unit	
Continuous Drain Current	T <sub>C</sub> = 25°C	T <sub>C</sub> = 25°C		47	Α	
	T <sub>C</sub> = 100°C		I <sub>D</sub>	28.2	A	
Pulsed Drain Current	(1	note1)	I <sub>D,pulse</sub>	141	А	
Gate-Source Voltage			$V_{GSS}$	±30	V	
Single Pulse Avalanche Energ	y (r	note2)	E <sub>AS</sub>	1160	mJ	
Repetitive Avalanche Energy (note2)			E <sub>AR</sub>	1.76	mJ	
Avalanche Current			I <sub>AR</sub>	8.7	А	
MOSFET dv/dt Ruggedness, V <sub>DS</sub> = 0480V			dv/dt	50	V/ns	
Power Dissipation For TO-220F			P <sub>D</sub>	37	W	
Power Dissipation For TO-247, TO-3PN			P <sub>D</sub>	391	W	
Continuous Diode Forward Current			I <sub>S</sub>	40		
Diode Pulsed Current (note1			I <sub>S,pulse</sub>	141	A	
Reverse Diode dv/dt (note3)		note3)	dv/dt	15	V/ns	
Maximum Diode Commutation Speed (note3)		note3)	di <sub>f</sub> /dt	500	A/µs	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55~+150	°C	

Thermal Resistance For TO-220F						
Parameter	Symbol	Value	Unit			
Thermal Resistance, Junction-to-Case	R <sub>thJC</sub>	3.37	°C/W			
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62	-0/00			

Thermal Resistance For TO-3PN,TO-247						
Parameter	Symbol	Value	Unit			
Thermal Resistance, Junction-to-Case	R <sub>thJC</sub>	0.32	°C/W			
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62	-0/00			



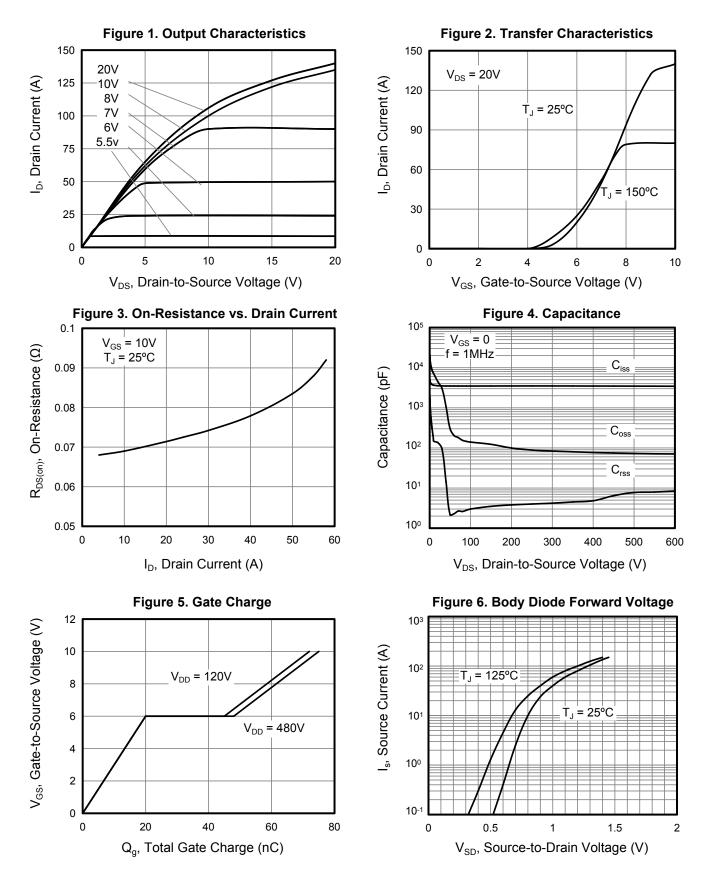
Demonstern			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0V, I_{D} = 250 \mu A$	600			V	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 25°C			1	^	
Zero Gale vollage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 150°C			100	μΑ	
Gate-Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 30V$			±100	nA	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2.5		4.5	V	
Drain-Source On-State-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 24A		0.073	0.08	Ω	
Gate Resistance	R <sub>G</sub>	f = 1.0MHz open drain		0.8		Ω	
Dynamic Characteristics	•						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V,		3488			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 100V,		140		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0MHz		3			
Total Gate Charge	Qg			75			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DD} = 480V, I_{D} = 47A, V_{GS} = 10V$		20		nC	
Gate-Drain Charge	$Q_{gd}$			28			
Turn-on Delay Time	t <sub>d(on)</sub>			23			
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 400V, I <sub>D</sub> = 47A,		85.8			
Turn-off Delay Time	t <sub>d(off)</sub>	$R_{G} = 25\Omega$		110.2		ns	
Turn-off Fall Time	t <sub>f</sub>			55.8			
Drain-Source Body Diode Character	istics						
Body Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25°C, I <sub>SD</sub> = 47A, V <sub>GS</sub> = 0V		0.9	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>			400		ns	
Reverse Recovery Charge	Q <sub>rr</sub>	V <sub>R</sub> = 400V, I <sub>F</sub> = 20A, di <sub>F</sub> /dt = 100A/µs		8		μC	
Peak Reverse Recovery Current	I <sub>rrm</sub>			39.8		А	

#### Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.  $I_{AS}$  = 8.7A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25°C
- 3. Identical low side and high side switch with identical  ${\sf R}_{\sf G}$

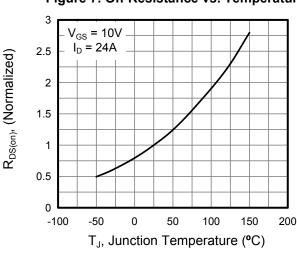


#### **Typical Characteristics** $T_J = 25^{\circ}C$ , unless otherwise noted

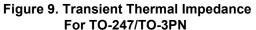


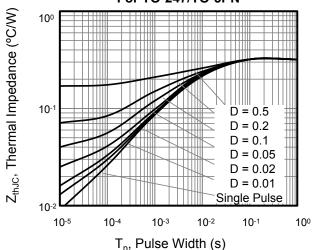


### **Typical Characteristics** $T_J = 25^{\circ}C$ , unless otherwise noted

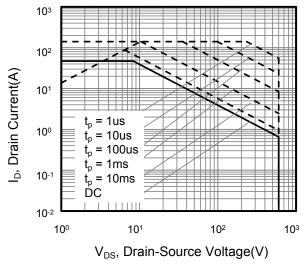


#### Figure 7. On-Resistance vs. Temperature









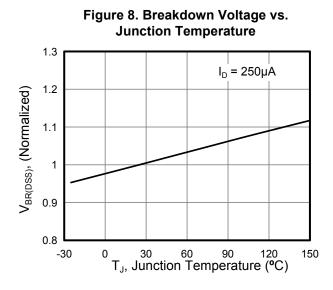


Figure 10. Transient Thermal Impedance For TO-220F

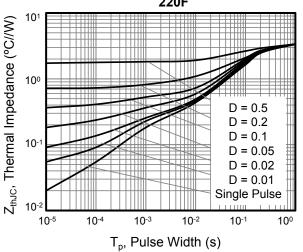
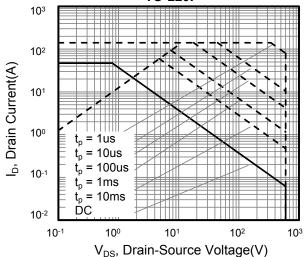


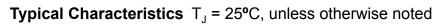
Figure 12. Safe operation area For TO-220F

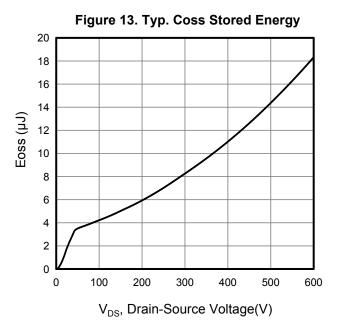


# TPA60R080M, TPV60R080M, TPW60R080M



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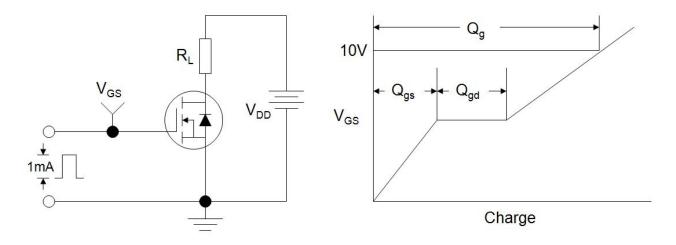


Figure B: Resistive Switching Test Circuit and Waveform

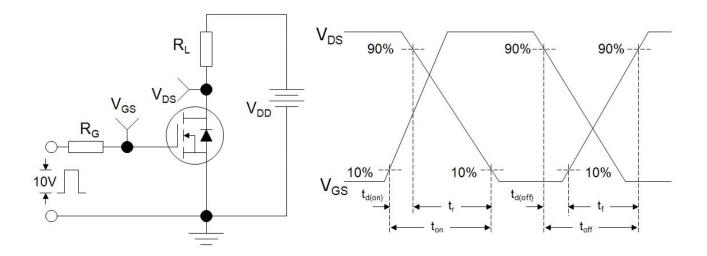
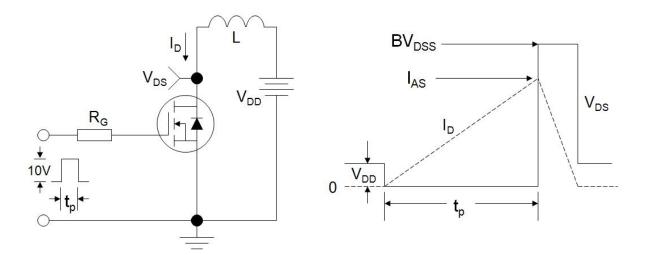
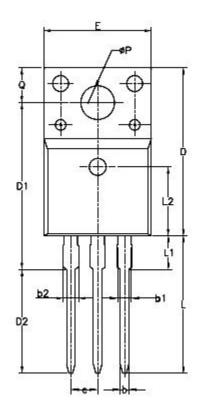


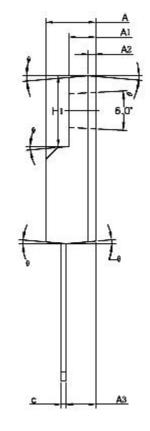
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

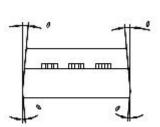




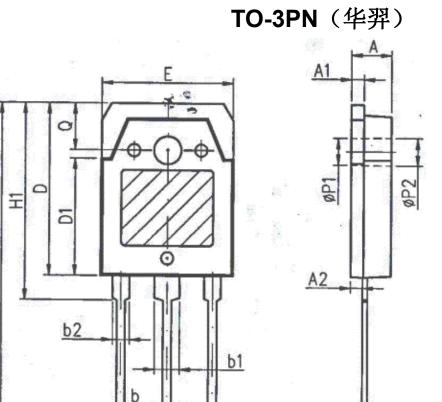
TO-220F(集佳)

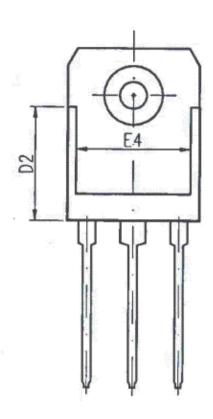






SYMBOL	MIN	NOM	MAX	
А	4.50	4.70	4.83	
A1	2.34	2.54	2.74	
A2		0.70 R	EF	
A3	2.56	2.76	2.93	
b	0.70	_	0.90	
b1	1.18	_	1.38	
b2	_	_	1.47	
с	0.45	0.50	0.60	
D	15.67	15.87	16.07	
D1	15.55	15.75	15.95	
D2	9.60	9.80	10.0	
E	9.96	10.16	10.36	
е	2	2.54BSC		
H1	6.48	6.68	6.88	
L	12.68	12.98	13.28	
L1	-	-	3.50	
L2	6.50REF			
ØΡ	3.08	3.18	3.28	
Q	3.20	_	3.40	
θ1	1'	3.	5'	





SYMBOL	Num			
	MIN	NOM	MAX	
A	4.60	4.80	5.00	
_A1	1.40	1.50	1.65	
A2	1.18	1.38	1.58	
b	0.80	1.00	1.20	
b1	2.80	3.00	3.20	
b2	1.80	2.00	2.20	
_ c	0.50	0.60	0.75	
D	19,60	19.90	20.20	
D1	13.55	13.90	14.25	
D2		12.90 REF		
E	15.35	15.60	15.85	
E4	12.60	-	-	
е	Sec. 25	5.45	TYP	
_H	40.10	40.50	40.90	
H1	23.15	23.40	23.65	
ΦΡ1	3.20 REF			
ΦP2	3.50 REF			

С

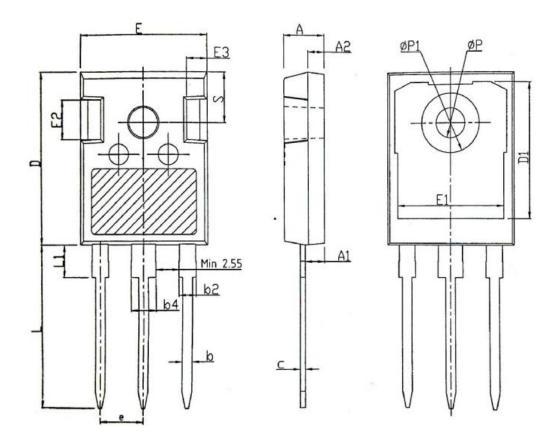
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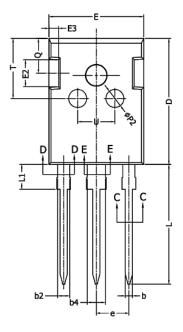
TO-247(华羿)

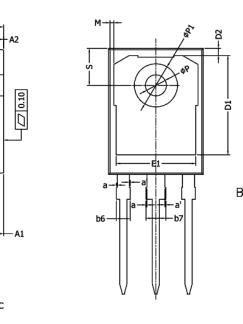


SYMBOL	Inter CONTROL US			
SINDUL	MIN	NUM	MAX	
A	4.80	5.00	5.20	
A1	2.21	2.41	2.59	
A2	1.85	2.00	2.15	
b	1.11	1.21	1.36	
b2	1.91	2.01	2.21	
b4	2.91	3.01	3.21	
с	0.51	0.61	0.75	
D	20.80	21.00	21.30	
D1	16.25	16.55	16.85	
E	15.50	15.80	16.10	
E1	13.00	13.30	13.60	
E2	4.80	5.00	5.20	
E3	2.30	2,50	2.70	
е		5. 44BSC		
L	19.82	19.92	20.22	
L1	-	-	4.30	
ΦP	3.40	3.60	3.80	
ΦΡ1	-	-	7.30	
S		6. 15BSC		

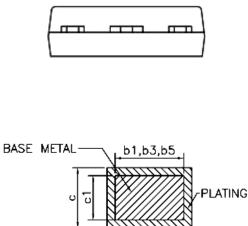


TO-247 (集佳)





С



b,b2,b4

SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0		0.15
a'	0		0.15
b	1.16		1.26
b1	1.15	1.2	1.22
b2	1.96		2.06
b3	1.95	2.00	2.02
b4	2.96		3.06
b5	2.96	3.00	3.02
b6			2.25
b7			3.25
с	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	2.40	2.50	2.60
e		5.436 BSC	
L	19.80	19.92	20.10
L1			4.30
М	0.35		0.95
Р	3.40	3.50	3.60
P1	7.00		7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S	6.05	6.15	6.25
Т	9.80		10.20
U	6.00		6.40



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